## **Tiou Wang**

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EDUCATION 2022		H II CHDIA
Sep.2019-Jun.2023	Harbin Institute of Technology  B.E. in Electronic Information Engineering at School of Electronics and Information Eng.  Undergraduate Cumulative Average Score:85.2/100	
Aug.2023-Jun.2025	KTH Royal Institute of Technology  M.S.C. in Information and Internetwork Engineering at School of EECS	
RESEARCH AND PROFE	SSIONAL REEXPERIENCES	
Sep.2022- May.2023	Research On CNN-based Infrared Weak Small Target Detection Method	
	Graduation Design	Harbin Institute of Technology
	Advisor: Prof. Junping Zhang(HIT)	
	<ul> <li>Analyzed the characteristics of infrared images and and models noise and background</li> <li>Employed a fusion image suppression method based on local contrast information entropy and saliency similarity initially</li> </ul>	
	Used a dense attention mechanism network to com	plete the detection
	<ul> <li>Taken several strategies to accelerate the training and reduce VRAM usage</li> <li>Completed an essay in Chinese</li> </ul>	
Jul.2022- Sep.2022	Digital Integrated Circuits (Introduction to design of Advisor: Prof. Dejan Marković (UCLA)	
	<ul> <li>Completed the online research seminar Digital Inte</li> <li>Gained the knowledge about digital circuits, VLSI</li> <li>Learned the fundamental modeling and factors of I</li> </ul>	, and processor architectures IC design
	Accumulated small scale integrated circuits design	
Sep.2020- Jun.2021	<ul> <li>Intelligent Hospital Bed to Assist Patients' Movements         <ul> <li>To predict the patients' further movements through deep learning of the pressure data of each support column on the bed, so as to assist the patient's movements by controlling the movement of different support columns, and continuously enhance the accuracy of motion recognition based on cloud data, as well as monitor the patients' data</li> </ul> </li> <li>Mainly responsible for setting up a cloud environment</li> </ul>	
	<ul> <li>Accomplished in the work of bed lifting construction design and neural network building</li> <li>Developed a deeper understanding of neural network application in image and gained fundamental knowledge of MCU</li> </ul>	
Oct.2019-Jun.2020	Study of Writing Styles Based on Deep Learning TEAM LEADER	Harbin Institute of Technology
	<ul> <li>To study about changing trends between Chinese characters of Running Hand based on convolutional network, and uses this as a training set to imitate the writing style</li> <li>Involved in the work of parameter debugging of network layer construction and training</li> <li>Assigned missions to members according to their strengths and organized periodic meetings about the progress</li> </ul>	
Nov.2022-Dec.2022	Fabrication of AM Modulation Circuit Transmitting and Receiving Based on Triode in High Frequency Electronic Circuit	
	Completed the work of circuit simulation and welcompleted the work of circuit simulation.	ling based on Multisim
	<ul> <li>Read numerous references and achieved optimizat.</li> </ul>	ion of emitter follower, pull-up resistor
INTERCHING	and cross coupling circuit	
INTERSHIPS Jan.2022- Mar.2022	Shanghai Fudan Microelectronics	Shanghai, CHINA
Jan. 2022- Mai. 2022	INTERN, INTERNET INNOVATION DEPARTMENT	
	Participated in the project of NIO Bluetooth car ke	
	• Involved in the program of the Ministry of Communications National Traffic NFC testing	
	Learned the communication protocol of Bluetooth and the remote-control architecture of modern cars    Description   Descrip	
	<ul> <li>Understood the project composition and test methor</li> <li>Accumulated knowledge and practice experience of environment testing of standard communication</li> </ul>	
SKILLS	environment testing of standard communication	
Language	Mandarin, English( TOEFL:100)	
Software	• Office	
Programming Languages	• MATLAB, C++, Python	